

CMLM0708A

**MULTI DISCRETE MODULE™
SURFACE MOUNT SILICON
N-CHANNEL AND P-CHANNEL
COMPLEMENTARY MOSFETS**



www.centrasemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMLM0708A is a Multi Discrete Module™ consisting of complementary N-Channel and P-Channel enhancement-mode MOSFETs packaged in a space saving SOT-563 case. This device is designed for small signal general purpose applications where size and operational efficiency are prime requirements.

MARKING CODE: C78



FEATURES:

- Dual Complementary MOSFETS
- Low $r_{DS(ON)}$ (3Ω MAX @ $V_{GS}=5.0V$)
- Small SOT-563 Surface Mount Package

APPLICATIONS:

- Switching Circuits
- DC-DC Converters
- Battery Powered Portable Equipment including Cell Phones, Digital Cameras, Pagers, PDAs, Notebook PCs, etc.

MAXIMUM RATINGS - CASE: ($T_A=25^\circ C$)

Power Dissipation (Note 1)	
Power Dissipation (Note 2)	
Power Dissipation (Note 3)	
Operating and Storage Junction Temperature	
Thermal Resistance	

SYMBOL		UNITS
P_D	350	mW
P_D	300	mW
P_D	150	mW
T_J, T_{stg}	-65 to +150	$^\circ C$
θ_{JA}	357	$^\circ C/W$

MAXIMUM RATINGS: ($T_A=25^\circ C$)

Drain-Source Voltage	V_{DS}
Drain-Gate Voltage	V_{DG}
Gate-Source Voltage	V_{GS}
Continuous Drain Current	I_D
Continuous Source Current (Body Diode)	I_S
Maximum Pulsed Drain Current	I_{DM}
Maximum Pulsed Source Current	I_{SM}

SYMBOL	N-Ch (Q1)	P-Ch (Q2)	UNITS
V_{DS}	60	50	V
V_{DG}	60	50	V
V_{GS}	40	20	V
I_D	280	280	mA
I_S	280	280	mA
I_{DM}	1.5	1.5	A
I_{SM}	1.5	1.5	A

ELECTRICAL CHARACTERISTICS: ($T_A=25^\circ C$ unless otherwise noted)

SYMBOL	TEST CONDITIONS	N-Ch (Q1)		P-Ch (Q2)		UNITS
		MIN	MAX	MIN	MAX	
I_{GSSF}, I_{GSSR}	$V_{GS}=20V, V_{DS}=0$	-	100	-	100	nA
I_{DSS} (N-Ch)	$V_{DS}=60V, V_{GS}=0$	-	1.0	-	-	μA
I_{DSS} (P-Ch)	$V_{DS}=50V, V_{GS}=0$	-	-	-	1.0	μA
I_{DSS} (N-Ch)	$V_{DS}=60V, V_{GS}=0, T_J=125^\circ C$	-	500	-	-	μA
I_{DSS} (P-Ch)	$V_{DS}=50V, V_{GS}=0, T_J=125^\circ C$	-	-	-	500	μA
$I_{D(ON)}$	$V_{GS}=10V, V_{DS}=10V$	500	-	500	-	mA
BV_{DSS}	$V_{GS}=0, I_D=10\mu A$	60	-	50	-	V

Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 4.0mm²
 (2) FR-4 Epoxy PC Board with copper mounting pad area of 4.0mm²
 (3) FR-4 Epoxy PC Board with copper mounting pad area of 1.4mm²

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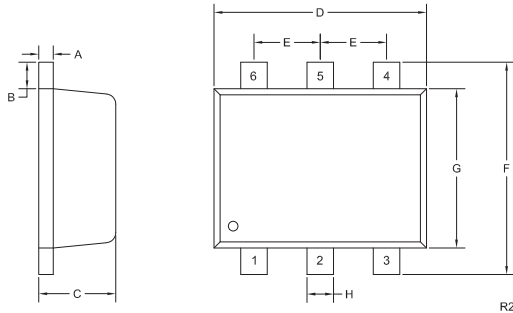
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ELECTRICAL CHARACTERISTICS - Continued: ($T_A=25^\circ\text{C}$ unless otherwise noted)

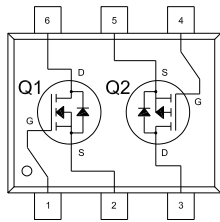
SYMBOL	TEST CONDITIONS	N-Ch (Q1)			P-Ch (Q2)			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0	-	2.5	1.0	-	2.5	V
$V_{DS(ON)}$	$V_{GS}=10\text{V}, I_D=500\text{mA}$	-	-	1.0	-	-	1.5	V
$V_{DS(ON)}$	$V_{GS}=5.0\text{V}, I_D=50\text{mA}$	-	-	0.15	-	-	0.15	V
V_{SD} (N-Ch)	$V_{GS}=0, I_S=400\text{mA}$	-	-	1.2	-	-	-	V
V_{SD} (P-Ch)	$V_{GS}=0, I_S=115\text{mA}$	-	-	-	-	-	1.3	V
$r_{DS(ON)}$	$V_{GS}=10\text{V}, I_D=500\text{mA}$	-	-	2.0	-	-	2.5	Ω
$r_{DS(ON)}$	$V_{GS}=10\text{V}, I_D=500\text{mA}, T_J=125^\circ\text{C}$	-	-	3.5	-	-	4.0	Ω
$r_{DS(ON)}$	$V_{GS}=5.0\text{V}, I_D=50\text{mA}$	-	-	3.0	-	-	3.0	Ω
$r_{DS(ON)}$	$V_{GS}=5.0\text{V}, I_D=50\text{mA}, T_J=125^\circ\text{C}$	-	-	5.0	-	-	5.0	Ω
g_{FS}	$V_{DS}=10\text{V}, I_D=200\text{mA}$	80	-	-	200	-	-	mS
C_{rss}	$V_{DS}=25\text{V}, V_{GS}=0, f=1.0\text{MHz}$	-	-	5.0	-	-	7.0	pF
C_{iss}	$V_{DS}=25\text{V}, V_{GS}=0, f=1.0\text{MHz}$	-	-	50	-	-	70	pF
C_{oss}	$V_{DS}=25\text{V}, V_{GS}=0, f=1.0\text{MHz}$	-	-	25	-	-	15	pF
$Q_{g(tot)}$ (N-Ch)	$V_{DS}=30\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	-	0.592	-	-	-	-	nC
Q_{gs} (N-Ch)	$V_{DS}=30\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	-	0.196	-	-	-	-	nC
Q_{gd} (N-Ch)	$V_{DS}=30\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	-	0.148	-	-	-	-	nC
$Q_{g(tot)}$ (P-Ch)	$V_{DS}=25\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	-	-	-	-	0.72	-	nC
Q_{gs} (P-Ch)	$V_{DS}=25\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	-	-	-	-	0.25	-	nC
Q_{gd} (P-Ch)	$V_{DS}=25\text{V}, V_{GS}=4.5\text{V}, I_D=100\text{mA}$	-	-	-	-	0.16	-	nC
t_{on}, t_{off}	$V_{DD}=30\text{V}, V_{GS}=10\text{V}, I_D=200\text{mA}$ $R_G=25\Omega, R_L=150\Omega$	-	-	20	-	-	20	ns

SOT-563 CASE - MECHANICAL OUTLINE



SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.0027	0.007	0.07	0.18
B	0.008		0.20	
C	0.017	0.024	0.45	0.60
D	0.059	0.067	1.50	1.70
E	0.020		0.50	
F	0.059	0.067	1.50	1.70
G	0.043	0.051	1.10	1.30
H	0.006	0.012	0.15	0.30

SOT-563 (REV: R2)

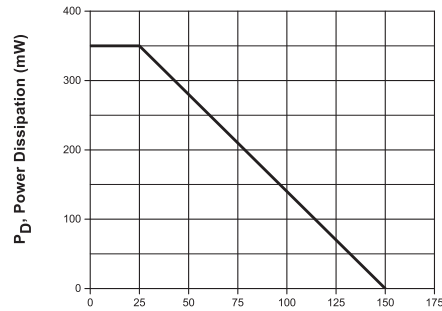


LEAD CODE:

- 1) Gate Q1
- 2) Source Q1
- 3) Drain Q2
- 4) Gate Q2
- 5) Source Q2
- 6) Drain Q1

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Power Derating



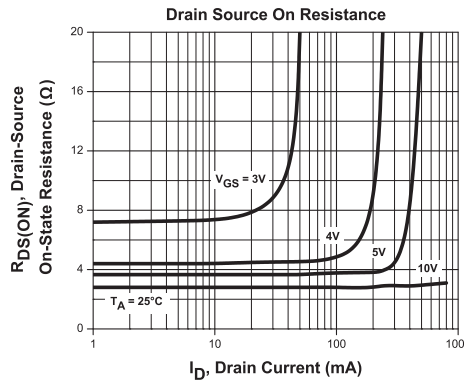
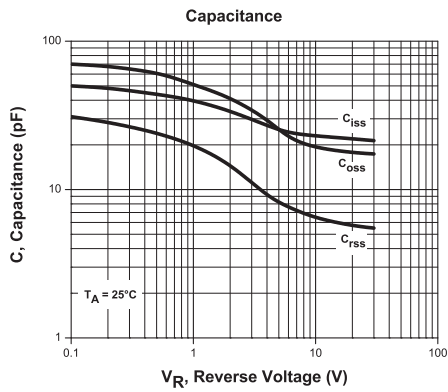
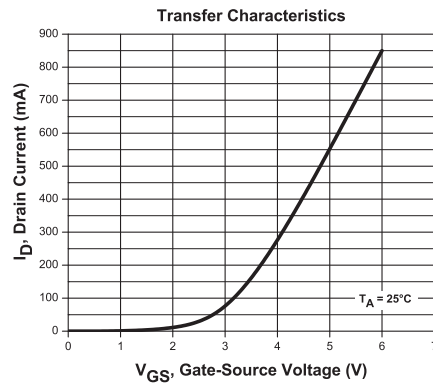
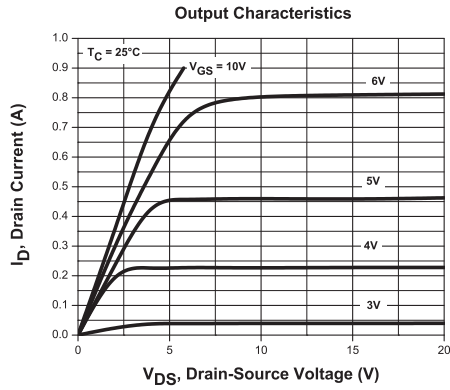
R4 (1-July 2015)

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N-CHANNEL TYPICAL ELECTRICAL CHARACTERISTICS



R4 (1-July 2015)

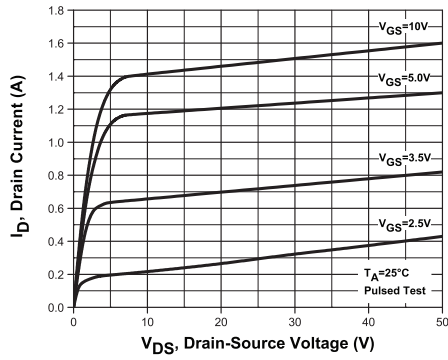
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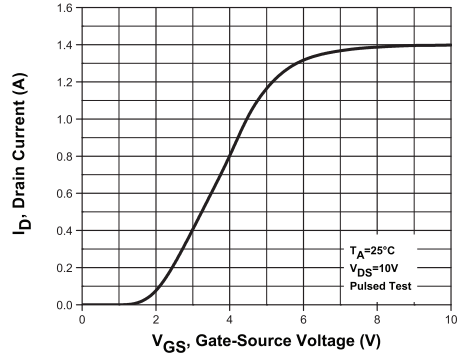


P-CHANNEL TYPICAL ELECTRICAL CHARACTERISTICS

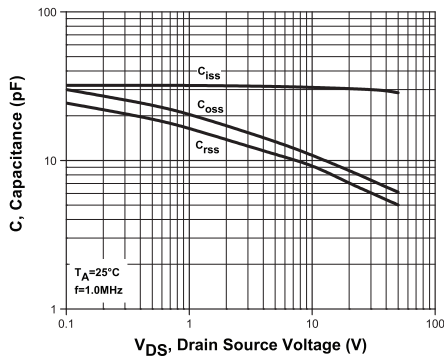
Output Characteristics



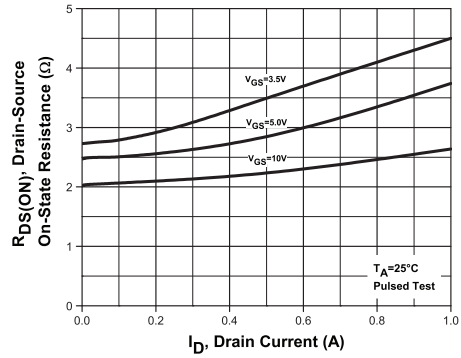
Transfer Characteristics



Capacitance



Drain Source On Resistance



R4 (1-July 2015)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- Consolidated shipping options
- Custom bar coding for shipments
- Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities
- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- Application and design sample kits
- Custom product and package development

REQUESTING PRODUCT PLATING

1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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